## **Boomer**<sup>®</sup> Audio Power Amplifier Series LM4946 **Output Capacitor-Less Audio Subsystem with Programmable National 3D General Description**

The LM4946 is an audio power amplifier capable of delivering 540mW of continuous average power into a mono  $8\Omega$ bridged-tied load (BTL) with 1% THD+N, 35mW per channel of continuous average power into stereo  $32\Omega$  single-ended (SE) loads with 1% THD+N, or an output capacitor-less (OCL) configuration with identical specifications as the SE configuration, from a 3.3V power supply.

The LM4946 has three input channels: one pair for a twochannel stereo signal and the third for a differential singlechannel mono input. The LM4946 features a 32-step digital volume control and eight distinct output modes. The digital volume control, 3D enhancement, and output modes (mono/ SE/OCL) are programmed through a two-wire I<sup>2</sup>C or a threewire SPI compatible interface that allows flexibility in routing and mixing audio channels.

The LM4946 is designed for cellular phone, PDA, and other portable handheld applications. It delivers high quality output power from a surface-mount package and requires only seven external components in the OCL mode (two additional components in SE mode).

## **Key Specifications**

■ THD+N at 1kHz, 540mW	
into 8Ω BTL (3.3V)	1.0% (typ)
■ THD+N at 1kHz, 35mW	
into 32Ω SE (3.3V)	1.0% (typ)
<ul> <li>Single Supply Operation (V<sub>DD</sub>)</li> </ul>	2.7 to 5.5V
I <sup>2</sup> C/SPI Single Supply Operation	2.2 to 5.5V

I<sup>2</sup>C/SPI Single Supply Operation

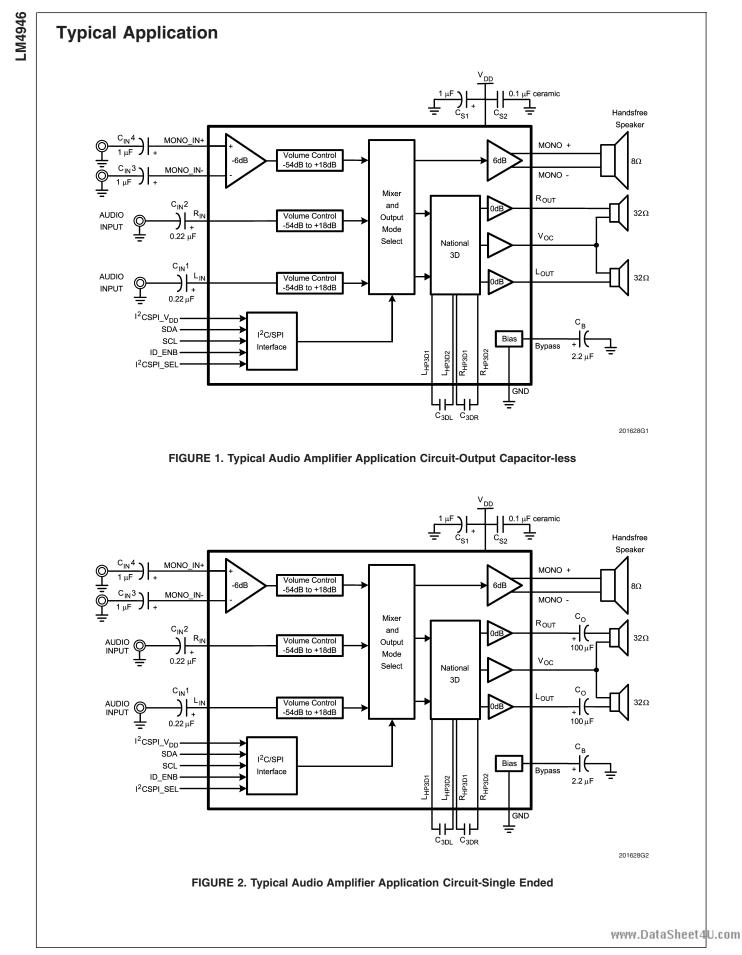
### Features

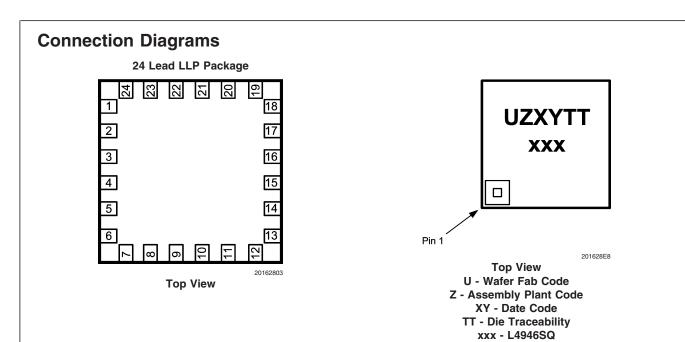
- I<sup>2</sup>C/SPI Control Interface
- I<sup>2</sup>C/SPI programmable National 3D Audio
- I<sup>2</sup>C/SPI controlled 32 step digital volume control (-54dB to +18dB)
- Three independent volume channels (Left, Right, Mono)
- Eight distinct output modes
- LLP surface mount packaging
- "Click and Pop" suppression circuitry
- Thermal shutdown protection
- Low shutdown current (0.02uA, typ)
- RF immunity topology

## Applications

- Mobile Phones
- PDAs

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# **Pin Descriptions**

1	LHP3D2	
	LIPSDZ	Left Headphone Input 2
2	VOC	Center Amplifier Output
3	VDD	Power Supply
4	GND	Ground
5	ROUT	Right Headphone Output
6	LOUT	Left Headphone Output
7	I <sup>2</sup> CSPI_VDD	I <sup>2</sup> C or SPI Interface Power Supply
8	RIN	Right Input Channel
9	LIN	Left Input Channel
10	SDA	I <sup>2</sup> C/SPI Data
11	SCL	I <sup>2</sup> C/SPI Clock
12	GND	Ground
13	ID_ENB	I <sup>2</sup> Address Identification/SPI Enable Bar
14	I <sup>2</sup> CSPI_SEL	I <sup>2</sup> C or SPI Select
15	MONO+	Loudspeaker Output Positive
16	VDD	Power Supply
17	MONO-	Loudspeaker Output Negative
18	LHP3D1	Left Headphone 3D Input 1
19	RHP3D1	Right Headphone 3D Input 1
20	GND	Ground
21	BYPASS	Half-Supply Bypass
22	MONO_IN-	Loudspeaker Negative Input
23	MONO_IN+	Loudspeaker Positive Input
24	RHP3D2	Right Headphone 3D Input 2

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# Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage	6.0V
Storage Temperature	–65°C to +150°C
Input Voltage	–0.3 to V <sub>DD</sub> +0.3
ESD Susceptibility (Note 3)	2.0kV
ESD Machine model (Note 6)	200V
Junction Temperature	150°C
Solder Information (Note 1)	

Vapor Phase (60 sec.)	215°C
Infrared (15 sec.)	220°C
Thermal Resistance (Note 8)	
θ <sub>JA</sub> (typ) - SQA24A	46°C/W

# **Operating Ratings**

Temperature Range	–40°C to 85°C
Supply Voltage (V <sub>DD</sub> )	$2.7V \leq V_{DD} \leq 5.5V$
Supply Voltage (I <sup>2</sup> C/SPI)	$2.2V \leq I^2 CSPI\_V_{DD} \leq 5.5V$

## Electrical Characteristics 3.3V (Notes 2, 7)

The following specifications apply for $V_{DD} = 3.3$	$V = 05^{\circ}$ of volume controls act to 0	dD unloss athenwise specified
The following specifications apply for $v_{PP} = 3.3$	V. $I_{\Lambda} = 23$ C. all volume controls set to U	JD. Unless otherwise specified.

Symbol	Parameter	Conditions	LM4	Units	
			Typical (Note 4)	Limits (Note 5)	(Limits)
		Output Modes 2, 4, 6 V <sub>IN</sub> = 0V; No load,	3.25		mA
		SE Headphone	3.25		IIIA
		Output Modes 1, 3, 5, 7			
		V <sub>IN</sub> = 0V; No load,	5.65		mA
		SE Headphone			
		Output Modes 2, 4, 6			
DD	Supply Current V <sub>IN</sub> = 0V; No load,	4	6.5	mA (max	
		OCL Headphone			
		Output Modes 1, 3, 5,			
		V <sub>IN</sub> = 0V; No load,	5		mA
		OCL Headphone			
		Output Modes 7			
		V <sub>IN</sub> = 0V; No load,	6.5	10.5	mA (max
		OCL Headphone			
SD	Shutdown Current	Output Mode 0	0.02	1	μA (max
V <sub>os</sub>		$V_{IN} = 0V$ , Mode 7	12	50	
	Output Offset Voltage	Mono	12	50	mV (max)
	Culput Chiset Voltage	$V_{IN} = 0V$ , Mode 7	3	30	
		Headphones	3	00	
		MONO <sub>OUT</sub> ; $R_L = 8\Omega$	540 500	mW (min	
Po	Output Power	THD+N = 1%; f = 1kHz, BTL, Mode 1	040	000	
0		$R_{OUT}$ and $L_{OUT}$ ; $R_L = 32\Omega$	35	30	mW (min
		THD+N = 1%; f = 1kHz, SE, Mode 4	00	00	
THD+N		MONO <sub>OUT</sub>			
		f = 1kHz	0.05		%
	Total Harmonic Distortion + Noise	$P_{OUT}$ = 250mW; $R_L$ = 8 $\Omega$ , BTL, Mode 1			
		R <sub>OUT</sub> and L <sub>OUT</sub>			
		f = 1kHz	0.015		%
		$P_{OUT} = 12mW; R_L = 32\Omega, SE, Mode 4$			

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Symbol	Parameter	= $3.3V$ , $T_A = 25^{\circ}C$ , all volume controls set to C Conditions	LM4	Units	
-			Typical (Note 4)	Limits (Note 5)	(Limits)
		A-weighted,			
		inputs terminated to GND, output referred			
		Speaker; Mode 1	17		μV
		Speaker; Mode 3, 7	27		μV
		Speaker; Mode 5	33		μV
N <sub>out</sub>	Output Noise	Headphone; SE, Mode 2	8		μV
		Headphone; SE, Mode 4, 7	8		μV
		Headphone; SE, Mode 6	12		μV
		Headphone; OCL, Mode 2	8		μV
		Headphone; OCL, Mode 4, 7	9		μV
		Headphone; OCL, Mode 6	12		μV
	Power Supply Rejection Ratio	$\label{eq:relation} \begin{split} V_{\text{RIPPLE}} &= 200 m V_{\text{PP}}; \ \text{f} = 217 \text{Hz}, \ \text{R}_{\text{L}} = 8 \Omega \\ C_{\text{B}} &= 2.2 \mu \text{F}, \ \text{BTL} \\ \text{All audio inputs terminated to GND;} \\ \text{output referred} \end{split}$			
	MONO <sub>OUT</sub>	BTL, Output Mode 1	76		dB
		BTL, Output Mode 3, 7	65		dB
		BTL, Output Mode 5	63		dB
PSRR	Power Supply Rejection Ratio $R_{OUT}$ and $L_{OUT}$	$V_{RIPPLE} = 200mV_{PP}$ ; f = 217Hz, R <sub>L</sub> = $32\Omega$ C <sub>B</sub> = $2.2\mu$ F, All audio inputs terminated to GND output referred			
		SE, Output Mode 2	78		dB
		SE, Output Mode 4,7	82		dB
		SE, Output Mode 6	78		dB
		OCL, Output Mode 2	84		dB
		OCL, Output Mode 4, 7	78		dB
		OCL, Output Mode 6	77		dB
	Volume Control Step Size Error		±0.2		dB
	Digital Volume Control Range	Maximum attenuation	-54	-56 -52	dB (max) dB (min)
	Digital Volume Control Hange	Maximum gain	18	17.4 18.6	dB (min) dB (max)
	HP(SE) Mute Attenuation	Output Mode 1, 3, 5	96		dB
	MONO_IN Input Impedance	Maximum gain setting	12.5	10 15	kΩ (min) kΩ (max)
	$R_{\text{IN}}$ and $L_{\text{IN}}$ Input Impedance	Maximum attenuation setting	110	90 130	kΩ (min) kΩ (max)
CMRR Common-Mode F		f = 217Hz, $V_{CM}$ = 1Vpp, Mode 1, BTL, $R_L$ = 8Ω	61		15
	Common-Mode Rejection Ratio	f = 217Hz, $V_{CM}$ = 1Vpp, Mode 2, $R_L$ = 32 $\Omega$	66		dB
	Creastell.	Headphone; $P_0 = 12mW$ f = 1kHz, OCL, mode 4	-54		dB
XTALK	Crosstalk	Headphone; $P_O = 12mW$ f = 1kHz, SE, mode 4	-72		dB
		$C_B = 2.2 \mu F$ , OCL	100		ms
Τ <sub>WU</sub>	Wake-Up Time from Shutdown	$C_{B} = 2.2\mu$ F, SE	135		ms

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Symbol	Parameter	Conditions	LM4946		ecified. Units
-			Typical (Note 4)	Limits (Note 5)	(Limits)
		Output Modes 2, 4, 6			
		V <sub>IN</sub> = 0V; No load	3.8		mA
		SE Headphone			
		Output Modes 1, 3, 5, 7			
		V <sub>IN</sub> = 0V; No Load,	6.6		mA
		SE Headphone			
		Output Modes 2, 4, 6			
DD	Supply Current	V <sub>IN</sub> = 0V; No load,	4.6		mA
		OCL Headphone			
		Output Modes 1, 3, 5			_
		V <sub>IN</sub> = 0V; No Load,	6		mA
		OCL Headphone			
		Output Modes 7			
		V <sub>IN</sub> = 0V; No Load,	7.4		mA
		OCL Headphone			
SD	Shutdown Current	Output Mode 0	0.05		μA
		V <sub>IN</sub> = 0V, Mode 7	12		mV
/ <sub>os</sub>	Output Offset Voltage	Mono			
00	e apar encor i enage	V <sub>IN</sub> = 0V, Mode 7	3		
		Headphones			
		$MONO_{OUT}; R_{L} = 8\Omega$	1.3		W
<b>`</b> o	Output Power	THD+N = 1%; f = 1kHz, BTL, Mode 1			
0		$R_{OUT}$ and $L_{OUT}$ ; $R_L = 32\Omega$ THD+N = 1%; f = 1kHz, SE, Mode 4	85		mW
		MONO <sub>OUT</sub> , f = 1kHz	0.05		%
THD+N	Total Harmonic Distortion + Noise	$P_{OUT} = 500 \text{mW}; \text{ R}_{L} = 8\Omega, \text{ BTL}, \text{ Mode 1}$	0.00		70
		$R_{OUT}$ and $L_{OUT}$ , f = 1kHz	0.012		%
		$P_{OUT} = 30$ mW; $R_L = 32\Omega$ , SE, Mode 4	0.012		/0
		A-weighted,			
		inputs terminated to GND, output referred			
		Speaker; Mode 1	17		μV
		Speaker; Mode 3, 7	27		μV
		Speaker; Mode 5	33		μV
I <sub>OUT</sub>	Output Noise	Headphone; SE, Mode 2	8		μV
		Headphone; SE, Mode 4, 7	8		μV
		Headphone; SE, Mode 6	12		μV
		Headphone; OCL, Mode 2	8		μV
		Headphone; OCL, Mode 4, 7	9		μV
		Headphone; OCL, Mode 6	12		μV
		$V_{\text{BIPPLE}} = 200 \text{mV}_{\text{PP}}$ ; f = 217Hz, R <sub>L</sub> = 8 $\Omega$			
		$C_{\rm B} = 2.2\mu$ F, BTL			
		All audio inputs terminated to GND;			
SRR	Power Supply rejection Ratio	output referred			
	MONO <sub>OUT</sub>	BTL, Output Mode 1	69		dB
		BTL, Output Mode 3, 7	60		dB
		BTL, Output Mode 5	58		dB

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Symbol	Parameter	Conditions	0dB, unless otherwise spo LM4946		Units	
			Typical (Note 4)	Limits (Note 5)	(Limits)	
		$V_{RIPPLE} = 200mV_{PP}$ ; f = 217Hz, R <sub>L</sub> = 32 $\Omega$ C <sub>B</sub> = 2.2 $\mu$ F, BTL All audio inputs terminated to GND; output referred				
	Power Supply Rejection Ratio	SE, Output Mode 2	75		dB	
PSRR	$R_{OUT}$ and $L_{OUT}$	SE, Output Mode 4,7	75		dB	
		SE, Output Mode 6	72		dB	
		OCL, Output Mode 2	75		dB	
		OCL, Output Mode 4, 7	79		dB	
		OCL, Output Mode 6	72		dB	
		Maximum attenuation	-54	-56 -52	dB (max) dB (min)	
	Digital Volume Control Range	Maximum gain	18	17.4 18.6	dB (min) dB (max)	
	HP(SE) Mute Attenuation	Output Mode 1, 3, 5	96		dB	
	MONO_IN Input Impedance	Maximum attenuation	12.5	10 15	kΩ (min) kΩ (max)	
	$\rm R_{IN}$ and $\rm L_{IN}$ Input Impedance	Maximum gain	110	90 130	kΩ (min) kΩ (max)	
	Common Made Dejection Datio	f = 217Hz, $V_{CM}$ = 1Vpp, 0dB gain Mode 1, BTL, $R_L$ = 8 $\Omega$	61			
CMRR	Common-Mode Rejection Ratio	f = 217Hz, $V_{CM}$ = 1Vpp, 0dB gain Mode 2, $R_L$ = 32 $\Omega$	66		dB	
VTALV	Croastalk	Headphone; P <sub>O</sub> = 30mW, OCL, mode 4	-55		dB	
XTALK	Crosstalk	Headphone; $P_{O} = 30$ mW, SE, mode 4	-72		dB	
TWU	Woke Lip Time from Chutdows	$C_B = 2.2\mu F, OCL$	135		ms	
wake-op hin	Wake-Up Time from Shutdown	С <sub>в</sub> = 2.2µF, SE	180		ms	

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# I<sup>2</sup>C/SPI (Notes 2, 7)

The following specifications apply fo	r V <sub>DD</sub> = 5.0V and 3.3V, $T_A = 25^{\circ}C$ , 2.2V	$\leq$ I <sup>2</sup> CSPI_V <sub>DD</sub> $\leq$ 5V, unless otherwise specified.

Symbol	Parameter	Conditions	LM	LM4946	
			Typical	Limits	(Limits)
			(Note 4)	(Note 5)	
t <sub>1</sub>	I <sup>2</sup> C Clock Period			2.5	µs (max)
t <sub>2</sub>	I <sup>2</sup> C Clock Setup Time			100	ns (min)
t <sub>3</sub>	I <sup>2</sup> C Data Hold Time			100	ns (min)
t <sub>4</sub>	Start Condition Time			100	ns (min)
t <sub>5</sub>	Stop Condition Time			100	ns (min)
f <sub>SPI</sub>	Maximum SPI Frequency			1000	kHz (max)
t <sub>EL</sub>	SPI ENB Low Time			100	ns (min)
t <sub>DS</sub>	SPI Data Setup Time			100	µs (max)
t <sub>ES</sub>	SPI ENB Setup Time			100	ns (min)
t <sub>DH</sub>	SPI Data Hold Time			100	ns (min)
t <sub>EH</sub>	SPI Enable Hold Time			100	ns (min)
t <sub>CL</sub>	SPI Clock Low Time			500	ns (min)
t <sub>CH</sub>	SPI Clock High Time			500	ns (min)
t <sub>cs</sub>	SPI Clock Transition Time			100	ns (min)
V <sub>IH</sub>	I <sup>2</sup> C/SPI Input Voltage High			0.7xl <sup>2</sup> CSPI	V (min)
				V <sub>DD</sub>	
V <sub>IL</sub>	I <sup>2</sup> C/SPI Input Voltage Low			0.3xl <sup>2</sup> CSPI	V (max)
				V <sub>DD</sub>	

Note 1: See AN-450 "Surface Mounting and their effects on Product Reliability" for other methods of soldering surface mount devices.

**Note 2:** Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 3: Human body model, 100pF discharged through a  $1.5 k\Omega$  resistor.

Note 4: Typical specifications are specified at +25°C and represent the most likely parametric norm.

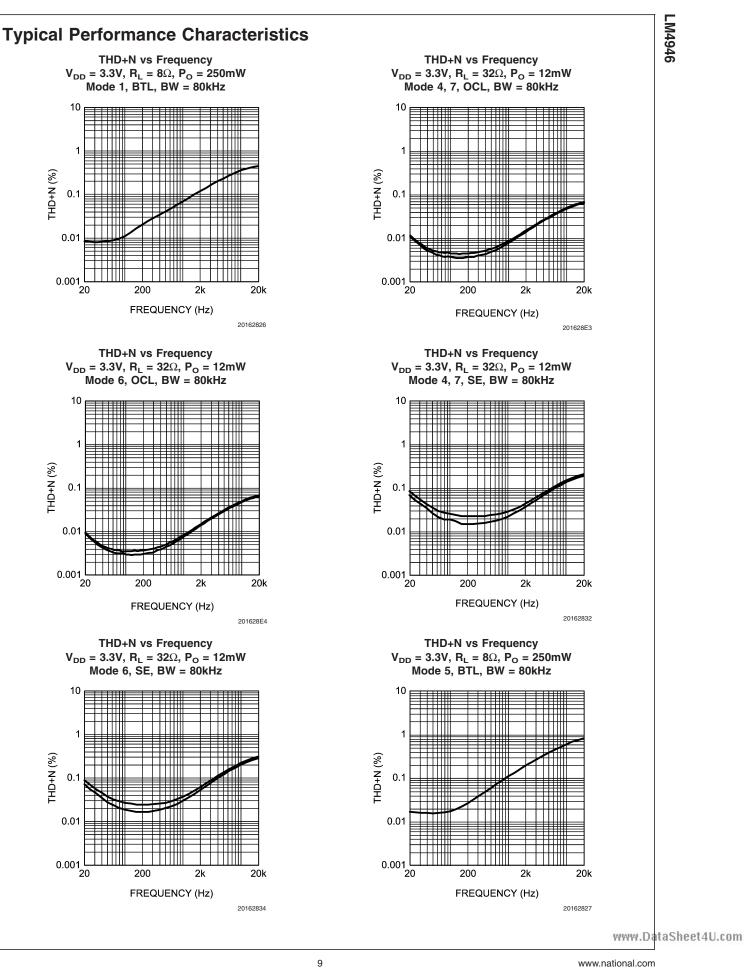
Note 5: Tested limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

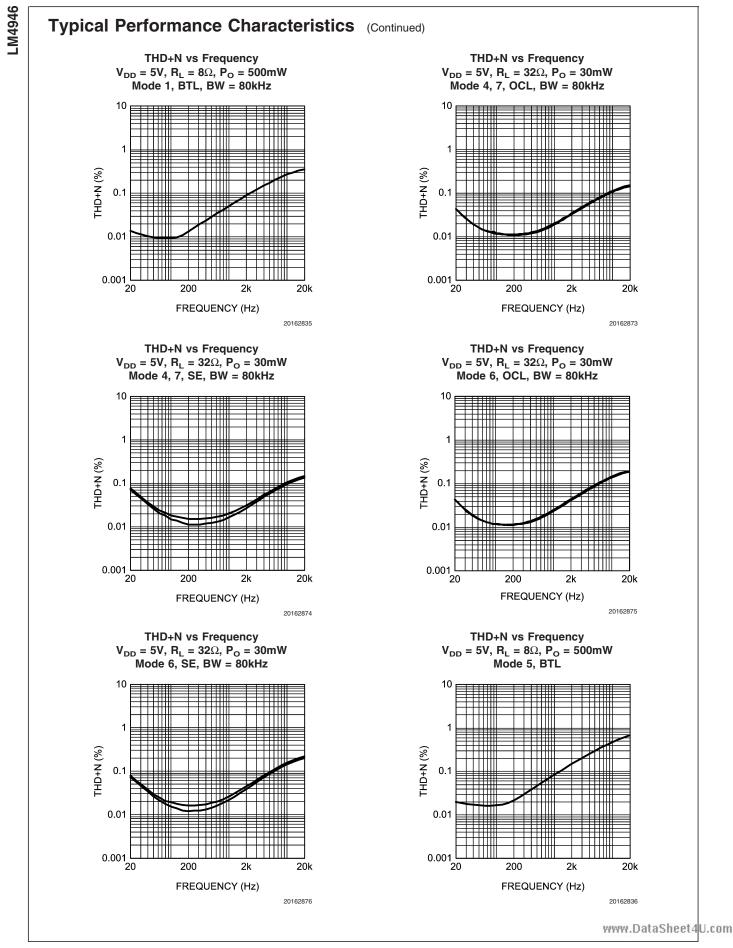
Note 6: Machine Model ESD test is covered by specification EIAJ IC-121-1981. A 200pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (resistance of discharge path must be under 50Ω).

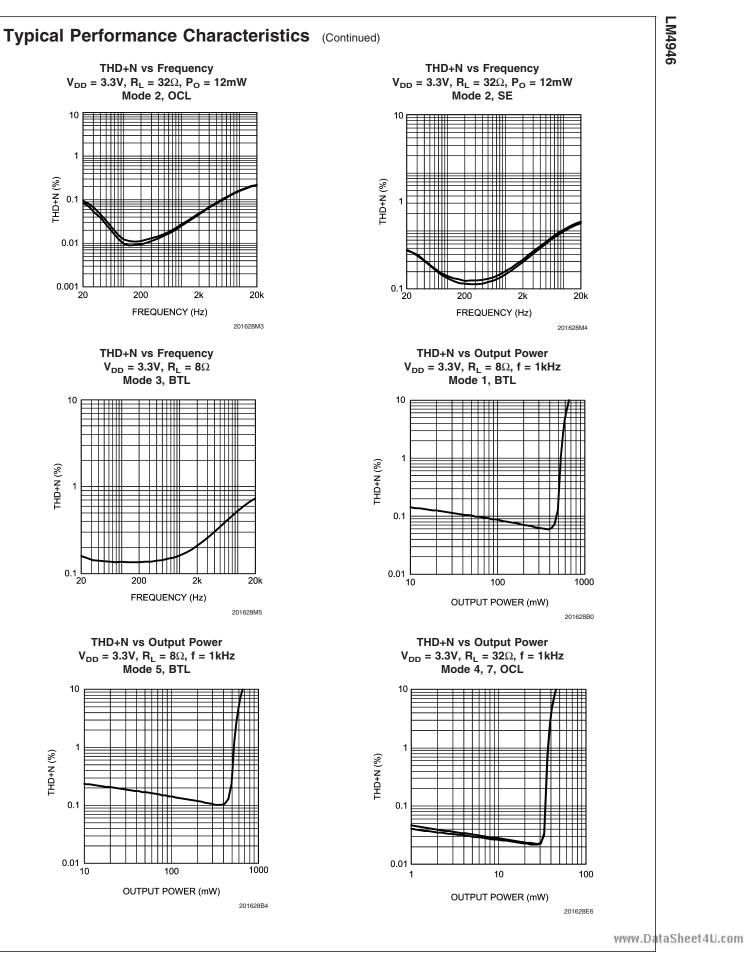
Note 7: All voltages are measured with respect to the ground pin, unless otherwise specified.

Note 8: The given  $\theta_{JA}$  for an LM4946SQ mounted on a demonstration board with a 9in<sup>2</sup> area of 1oz printed circuit board copper ground plane.

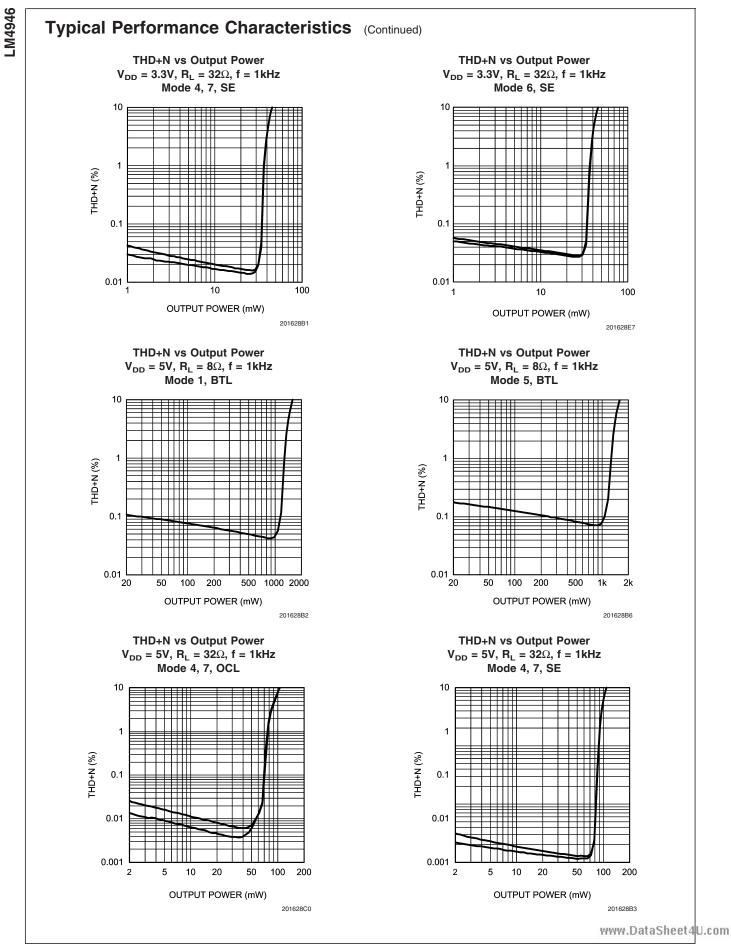
Note 9: Datasheet min/max specifications are guaranteed by design, test, or statistical analysis.

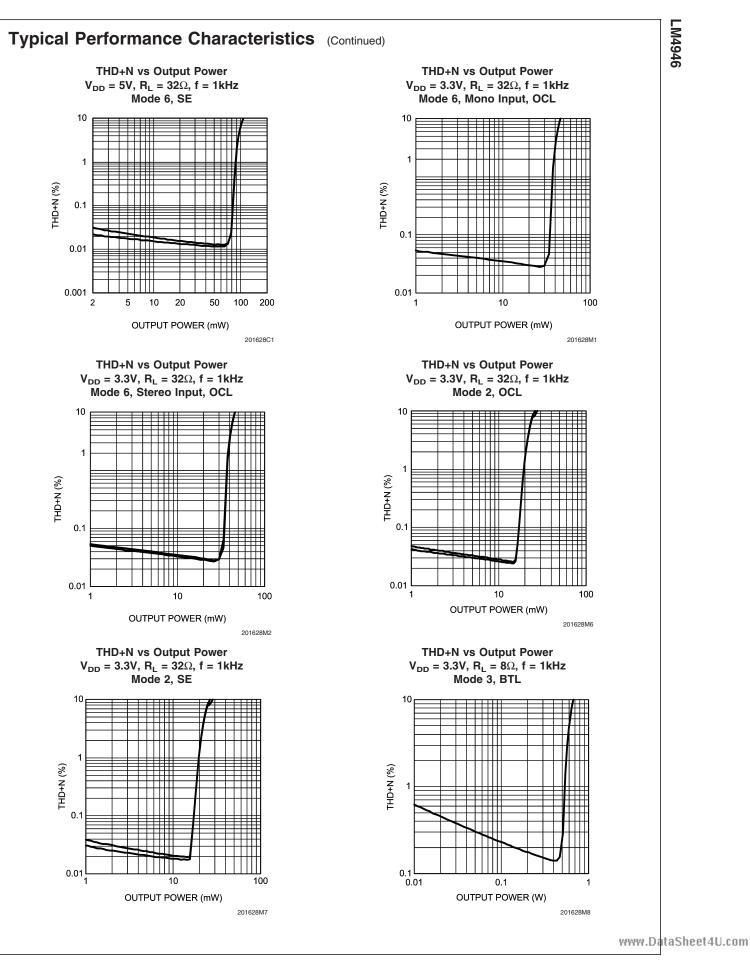


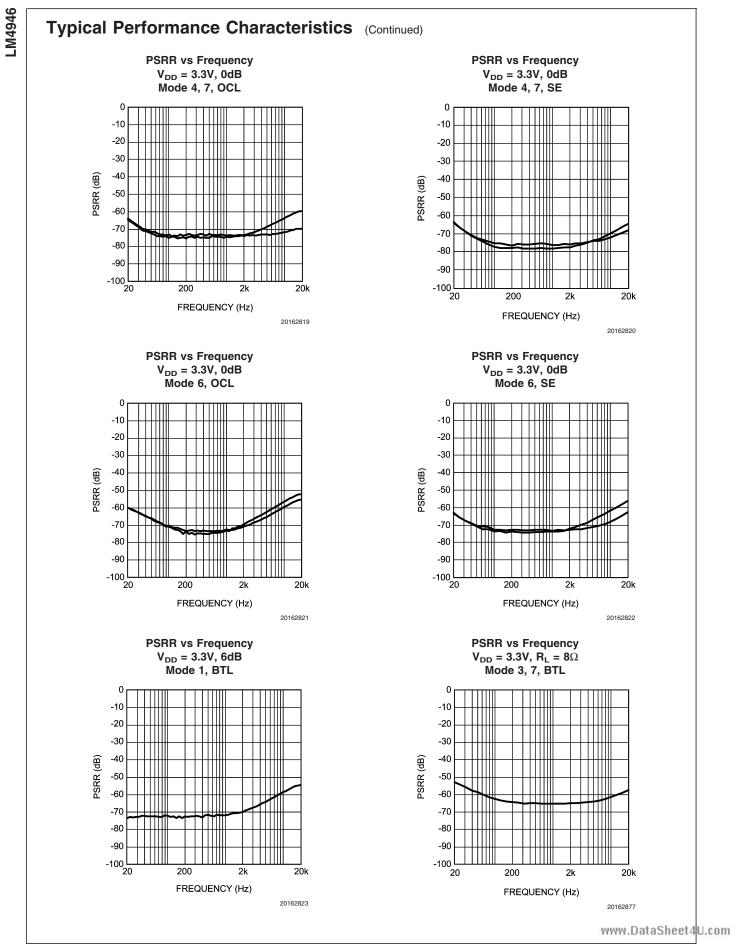


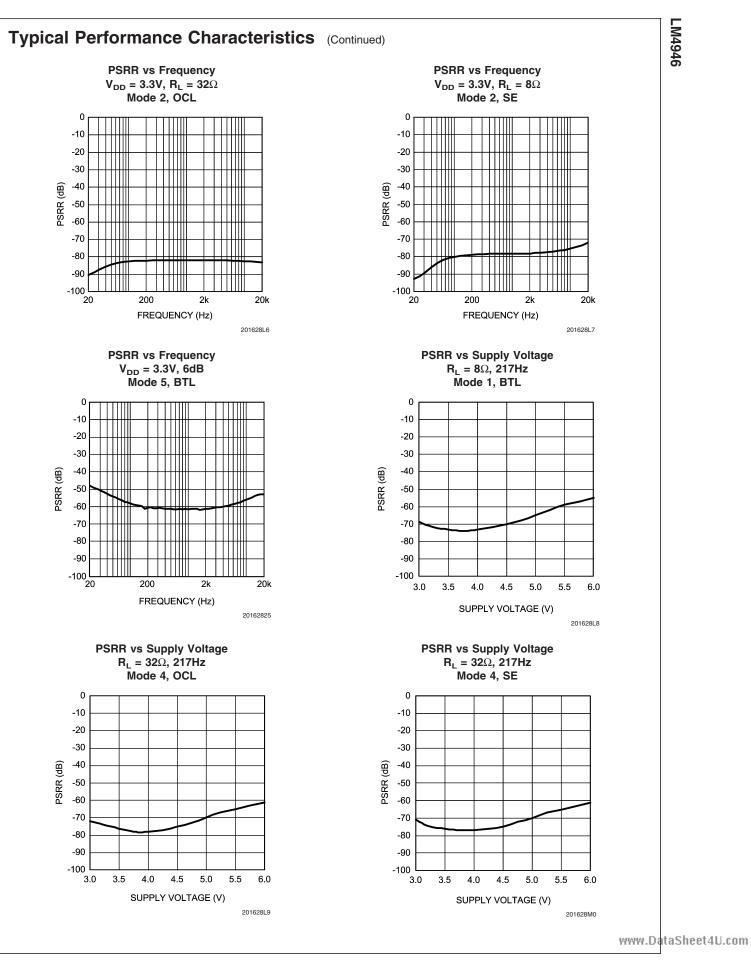


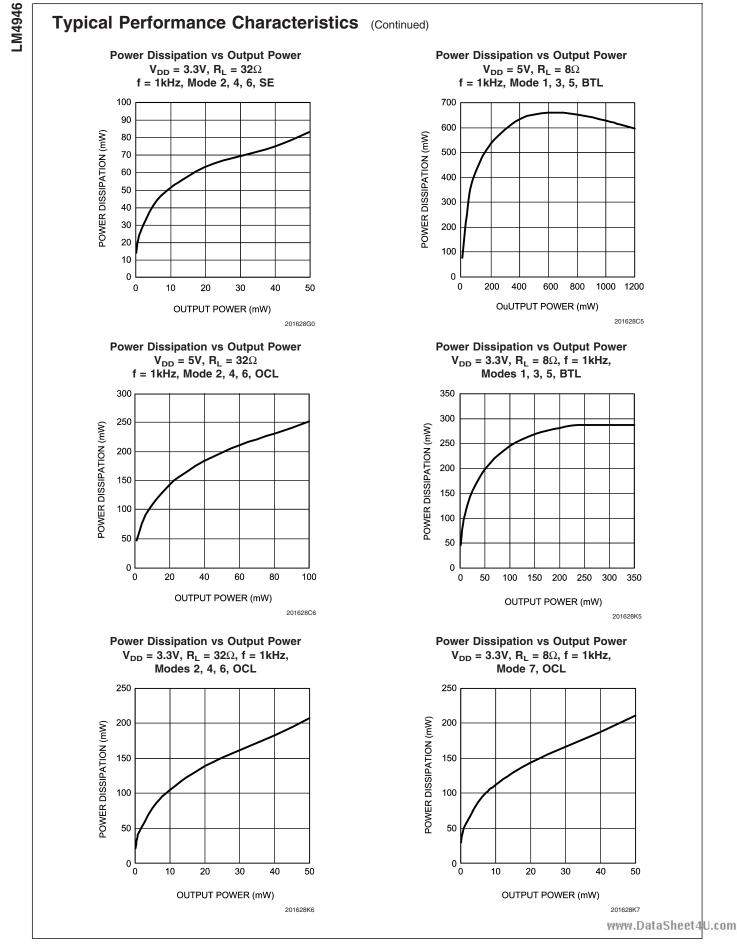
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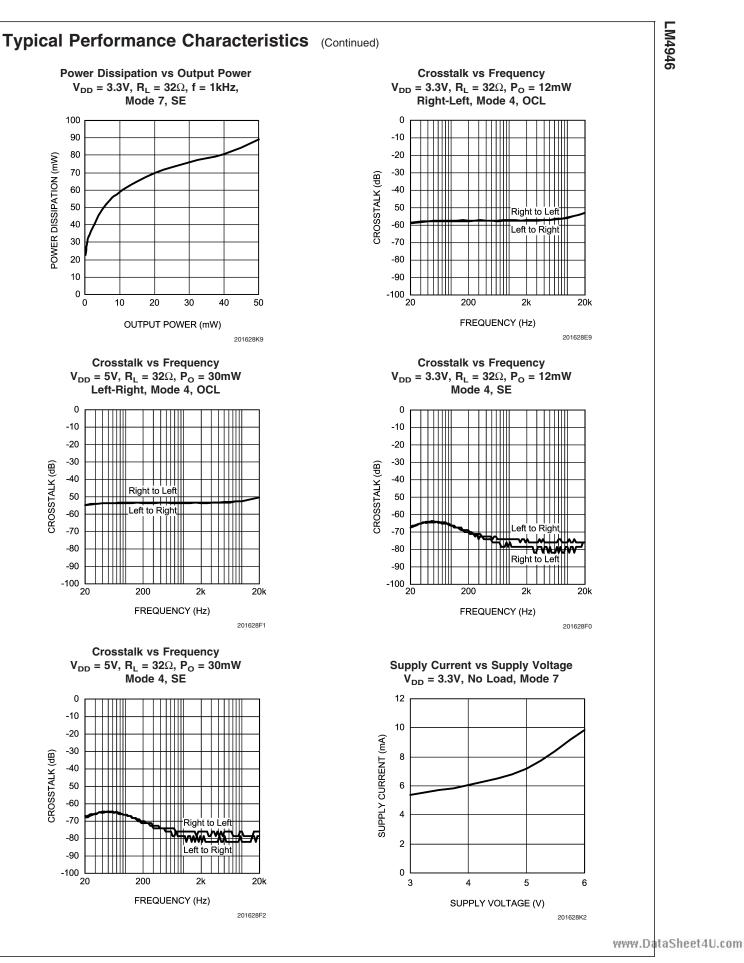


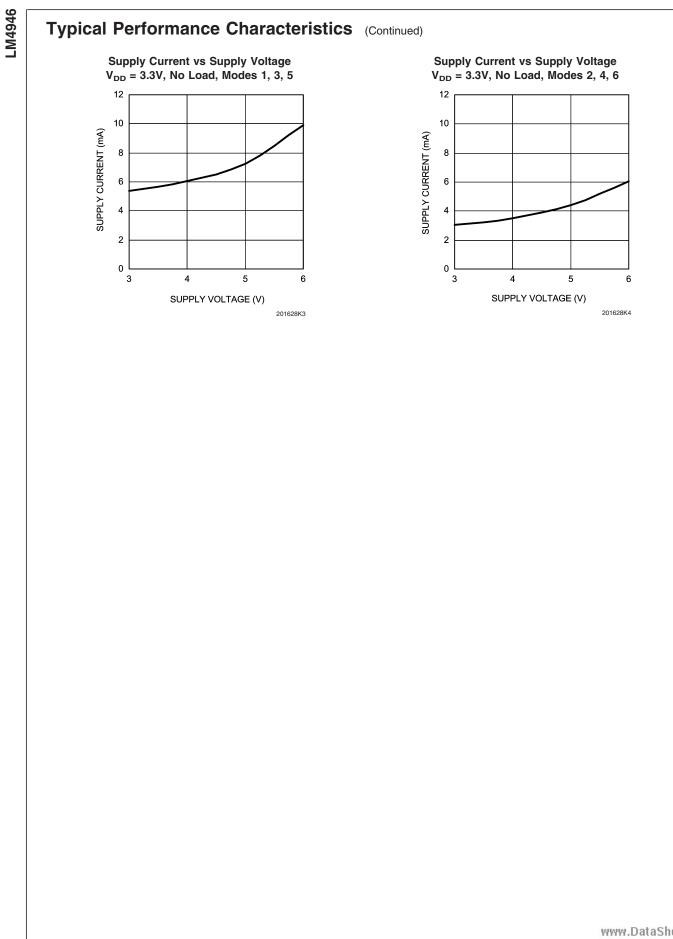












# **Application Information**

#### I<sup>2</sup>C PIN DESCRIPTION

SDA: This is the serial data input pin. SCL: This is the clock input pin. ID\_ENB: This is the address select input pin.

I<sup>2</sup>CSPI\_SEL: This is tied LOW for I<sup>2</sup>C mode.

#### I<sup>2</sup>C COMPATIBLE INTERFACE

The LM4946 uses a serial bus which conforms to the  $I^2C$  protocol to control the chip's functions with two wires: clock (SCL) and data (SDA). The clock line is uni-directional. The data line is bi-directional (open-collector). The maximum clock frequency specified by the  $I^2C$  standard is 400kHz. In this discussion, the master is the controlling microcontroller and the slave is the LM4946.

The I<sup>2</sup>C address for the LM4946 is determined using the ID\_ENB pin. The LM4946's two possible I<sup>2</sup>C chip addresses are of the form 111110X<sub>1</sub>0 (binary), where X<sub>1</sub> = 0, if ID\_ENB is logic LOW; and X<sub>1</sub> = 1, if ID\_ENB is logic HIGH. If the I<sup>2</sup>C interface is used to address a number of chips in a system, the LM4946's chip address can be changed to avoid any possible address conflicts.

The bus format for the I<sup>2</sup>C interface is shown in Figure 3. The bus format diagram is broken up into six major sections:

The "start" signal is generated by lowering the data signal while the clock signal is HIGH. The start signal will alert all devices attached to the  $I^2C$  bus to check the incoming address against their own address.

The 8-bit chip address is sent next, most significant bit first. The data is latched in on the rising edge of the clock. Each address bit must be stable while the clock level is HIGH. For I<sup>2</sup>C interface operation, the I<sup>2</sup>CSPI\_SEL pin needs to be tied LOW (and tied high for SPI operation).

After the last bit of the address bit is sent, the master releases the data line HIGH (through a pull-up resistor). Then the master sends an acknowledge clock pulse. If the LM4946 has received the address correctly, then it holds the data line LOW during the clock pulse. If the data line is not held LOW during the acknowledge clock pulse, then the master should abort the rest of the data transfer to the LM4946.

The 8 bits of data are sent next, most significant bit first. Each data bit should be valid while the clock level is stable HIGH.

After the data byte is sent, the master must check for another acknowledge to see if the LM4946 received the data.

If the master has more data bytes to send to the LM4946, then the master can repeat the previous two steps until all data bytes have been sent.

The "stop" signal ends the transfer. To signal "stop", the data signal goes HIGH while the clock signal is HIGH. The data line should be held HIGH when not in use.

#### I<sup>2</sup>C INTERFACE POWER SUPPLY PIN (I<sup>2</sup>CV<sub>DD</sub>)

The LM4946's  $I^2C$  interface is powered up through the  $I^2CV_{DD}$  pin. The LM4946's  $I^2C$  interface operates at a voltage level set by the  $I^2CV_{DD}$  pin which can be set independent to that of the main power supply pin  $V_{DD}$ . This is ideal whenever logic levels for the  $I^2C$  interface are dictated by a microcontroller or microprocessor that is operating at a lower supply voltage than the main battery of a portable system.

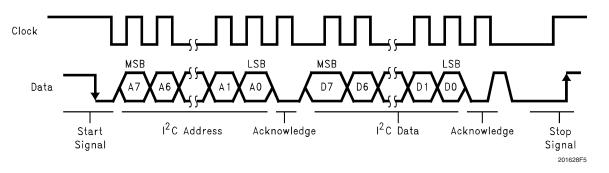
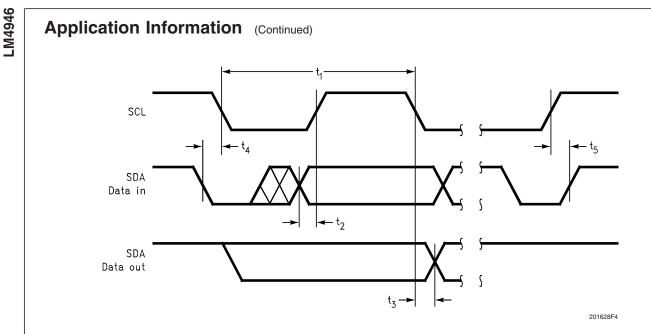


FIGURE 3. I<sup>2</sup>C Bus Format

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#### SPI DESCRIPTION

0. I<sup>2</sup>CSPI\_SEL: This pin is tied HIGH for SPI mode.

1. The data bits are transmitted with the MSB first.

2. The maximum clock rate is 1MHz for the CLK pin.

3. CLK must remain HIGH for at least 500ns ( $t_{CH}$ ) after the rising edge of CLK, and CLK must remain LOW for at least 500ns ( $t_{CL}$ ) after the falling edge of CLK.

4. The serial data bits are sampled at the rising edge of CLK. Any transition on DATA must occur at least 100ns ( $t_{DS}$ ) before the rising edge of CLK. Also, any transition on DATA must occur at least 100ns ( $t_{DH}$ ) after the rising edge of CLK and stabilize before the next rising edge of CLK.

 $5.\text{ID}\_\text{ENB}$  should be LOW only during serial data transmission.

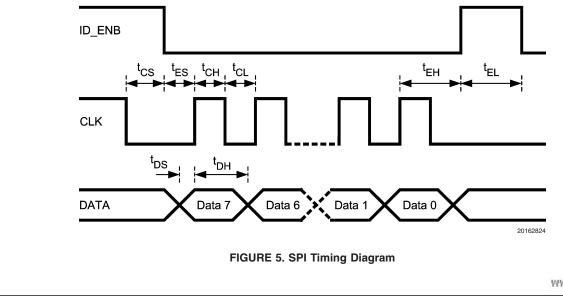
6. ID\_ENB must be LOW at least 100ns (t<sub>ES</sub>) before the first rising edge of CLK, and ID\_ENB has to remain LOW at least 100ns (t<sub>EH</sub>) after the eighth rising edge of CLK.

7. If ID\_ENB remains HIGH for more than 100ns before all 8 bits are transmitted then the data latch will be aborted.

8. If ID\_ENB is LOW for more than 8 CLK pulses then only the first 8 data bits will be latched and activated when ID\_ENB transitions to logic-high.

9. ID\_ENB must remain HIGH for at least 100ns (t\_{EL}) to latch in the data.

10. Coincidental rising or falling edges of CLK and ID\_ENB are not allowed. If CLK is to be held HIGH after the data transmission, the falling edge of CLK must occur at least 100ns ( $t_{\rm CS}$ ) before ID\_ENB transitions to LOW for the next set of data.



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TABLE	1.	Chip	Address
		•p	/

	A7	A6	A5	A4	A3	A2	A1	A0
Chip Address	1	1	1	1	1	0	EC	0
$ID_ENB = 0$	1	1	1	1	1	0	0	0
ID_ENB = 1	1	1	1	1	1	0	1	0

EC — Externally Controlled

#### **TABLE 2. Control Registers**

	D7	D6	D5	D4	D3	D2	D1	D0
Mode Control	0	0	0	0	OCL	MC2	MC1	MC0
Programmable 3D	0	1	0	0	N3D3	N3D2	N3D1	N3D0
Mono Volume Control	1	0	0	MVC4	MVC3	MVC2	MVC1	MVC0
Left Volume Control	1	1	0	LVC4	LVC3	LVC2	LVC1	LVC0
Right Volume Control	1	1	1	RVC4	RVC3	RVC2	RVC1	RVC0

1. Bits MVC0 — MVC4 control 32 step volume control for MONO input 2. Bits LVC0 — LVC4 control 32 step volume control for LEFT input

3. Bits RVC0 — RVC4 control 32 step volume control for RIGHT input 4. Bits MC0 — MC2 control 8 distinct modes

5. Bits N3D3, N3D2, N3D1, N3D0 control programmable 3D function

6. N3D0 turns the 3D function ON (N3D0 = 1) or OFF (N3D0 = 0), and N3D1 = 0 provides a "wider" aural effect or N3D1 = 1 a "narrower" aural effect

7. Bit OCL selects between SE with output capacitor (OCL = 0) or SE without output capacitors (OCL = 1). Default is OCL = 0

#### **TABLE 3. Programmable National 3D Audio**

	N3D3	N3D2
Low	0	0
Medium	0	1
High	1	0
Maximum	1	1

Output	MC2	MC1	MC0	Handsfree Speaker	Right HP Output	Left HP Output
Mode				Output		
Number						
0	0	0	0	SD	SD	SD
1	0	0	1	G <sub>P</sub> X P	MUTE	MUTE
2	0	1	0	SD	G <sub>P</sub> X P/2	G <sub>P</sub> X P/2
3	0	1	1	2 X (G <sub>L</sub> X L + G <sub>R</sub> X R)	MUTE	MUTE
4	1	0	0	SD	G <sub>R</sub> X R	G <sub>L</sub> X L
5	1	0	1	2 X (G <sub>L</sub> X L + G <sub>R</sub> X R) +	MUTE	MUTE
				G <sub>P</sub> X P		
6	1	1	0	SD	G <sub>R</sub> X R + G <sub>P</sub> X P/2	G <sub>L</sub> X L + G <sub>P</sub> X P/2
7	1	1	1	2 X (G <sub>R</sub> X R + G <sub>L</sub> X L)	G <sub>R</sub> X R	G <sub>L</sub> X L

#### **TABLE 4. Output Mode Selection**

On initial POWER ON, the default mode is 000

P = Phone-in (Mono)

 $R = R_{IN}$ 

 $L = L_{IN}$ 

SD = Shutdown

MUTE = Mute Mode

 $G_P$  = Phone In (Mono) volume control gain  $G_R$  = Right stereo volume control gain

 $G_L$  = Left stereo volume control gain

Volume Step	xVC4	xVC3	xVC2	xVC1	xVC0	Gain,dB
1	0	0	0	0	0	-54.00
2	0	0	0	0	1	-46.50
3	0	0	0	1	0	-40.50
4	0	0	0	1	1	-34.50
5	0	0	1	0	0	-30.00
6	0	0	1	0	1	-27.00
7	0	0	1	1	0	-24.00
8	0	0	1	1	1	-21.00
9	0	1	0	0	0	-18.00
10	0	1	0	0	1	-15.00
11	0	1	0	1	0	-13.50
12	0	1	0	1	1	-12.00
13	0	1	1	0	0	-10.50
14	0	1	1	0	1	-9.00
15	0	1	1	1	0	-7.50
16	0	1	1	1	1	-6.00
17	1	0	0	0	0	-4.50
18	1	0	0	0	1	-3.00
19	1	0	0	1	0	-1.50
20	1	0	0	1	1	0.00
21	1	0	1	0	0	1.50
22	1	0	1	0	1	3.00
23	1	0	1	1	0	4.50
24	1	0	1	1	1	6.00
25	1	1	0	0	0	7.50
26	1	1	0	0	1	9.00
27	1	1	0	1	0	10.50
28	1	1	0	1	1	12.00
29	1	1	1	0	0	13.50
30	1	1	1	0	1	15.00
31	1	1	1	1	0	16.50
32	1	1	1	1	1	18.00

 1. x = M, L, or R

 2. Gain / Attenuation is from input to output

#### NATIONAL 3D ENHANCEMENT

The LM4946 features a stereo headphone, 3D audio enhancement effect that widens the perceived soundstage from a stereo audio signal. The 3D audio enhancement creates a perceived spatial effect optimized for stereo headphone listening. The LM4946 can be programmed for a "narrow" or "wide" soundstage perception. The narrow soundstage has a more focused approaching sound direction, while the wide soundstage has a spatial, theater-like effect. Within each of these two modes, four discrete levels of 3D effect that can be programmed: low, medium, high, and maximum (Table 2, 3), each level with an ever increasing aural effect, respectively. The difference between each level is 3dB.

The external capacitors, shown in Figure 6, are required to enable the 3D effect. The value of the capacitors set the cutoff frequency of the 3D effect, as shown by Equations 1 and 2. Note that the internal  $20k\Omega$  resistor is nominal.

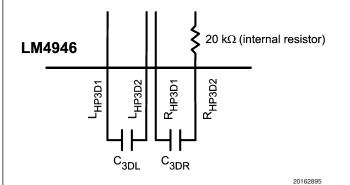


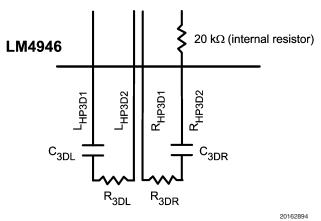
FIGURE 6. External 3D Effect Capacitors

$$f_{3DL(-3dB)} = 1 / 2\pi * 20k\Omega * C_{3DL}$$
(1)

 $f_{3DR(-3dB)} = 1 / 2\pi * 20k\Omega * C_{3DR}$ 

LM4946

Optional resistors  $R_{3DL}$  and  $R_{3DR}$  can also be added (Figure 7) to affect the -3dB frequency and 3D magnitude.



# FIGURE 7. External RC Network with Optional $\rm R_{3DL}$ and $\rm R_{3DR}$ Resistors

$$f_{3DL(-3dB)} = 1 / 2\pi * (20k\Omega + R_{3DL}) * C_{3DL}$$
 (3)

$$f_{3DR(-3dB)} = 1 / 2\pi * 20k\Omega + R_{3DR}) * C_{3DR}$$
(4)

 $\Delta AV$  (change in AC gain) = 1 / 1 + M, where M represents some ratio of the nominal internal resistor,  $20k\Omega$  (see example below).

$$f_{3dB} (3D) = 1 / 2\pi (1 + M)(20k\Omega * C_{3D})$$
 (5)

$$C_{Equivalent} (new) = C_{3D} / 1 + M$$
 (6)

TABLE 6. Pole Locations

R <sub>3D</sub> (kΩ) (optional)	C <sub>3D</sub> (nF)	М	∆AV (dB)	f-3dB (3D) (Hz)	Value of C <sub>3D</sub> to keep same pole location (nF)	new Pole Location (Hz)
0	68	0	0	117		
1	68	0.05	-0.4	111	64.8	117
5	68	0.25	-1.9	94	54.4	117
10	68	0.50	-3.5	78	45.3	117
20	68	1.00	-6.0	59	34.0	117

# PCB LAYOUT AND SUPPLY REGULATION CONSIDERATIONS FOR DRIVING $8\Omega$ LOAD

Power dissipated by a load is a function of the voltage swing across the load and the load's impedance. As load impedance decreases, load dissipation becomes increasingly dependent on the interconnect (PCB trace and wire) resistance between the amplifier output pins and the load's connections. Residual trace resistance causes a voltage drop, which results in power dissipated in the trace and not in the load as desired. For example,  $0.1\Omega$  trace resistance reduces the output power dissipated by an  $8\Omega$  load from 158.3mW to

156.4mW. The problem of decreased load dissipation is exacerbated as load impedance decreases. Therefore, to maintain the highest load dissipation and widest output voltage swing, PCB traces that connect the output pins to a load must be as wide as possible.

Poor power supply regulation adversely affects maximum output power. A poorly regulated supply's output voltage decreases with increasing load current. Reduced supply voltage causes decreased headroom, output signal clipping, and reduced output power. Even with tightly regulated supplies, trace resistance creates the same effects as poor

supply regulation. Therefore, making the power supply traces as wide as possible helps maintain full output voltage swing.

#### **BRIDGE CONFIGURATION EXPLANATION**

The LM4946 drives a load, such as a speaker, connected between outputs, MONO+ and MONO-.

This results in both amplifiers producing signals identical in magnitude, but 180° out of phase. Taking advantage of this phase difference, a load is placed between MONO- and MONO+ and driven differentially (commonly referred to as "bridge mode"). This results in a differential or BTL gain of:

$$A_{VD} = 2(R_f / R_i) = 2$$
 (7)

Bridge mode amplifiers are different from single-ended amplifiers that drive loads connected between a single amplifier's output and ground. For a given supply voltage, bridge mode has a distinct advantage over the single-ended configuration: its differential output doubles the voltage swing across the load. Theoretically, this produces four times the output power when compared to a single-ended amplifier under the same conditions. This increase in attainable output power assumes that the amplifier is not current limited and that the output signal is not clipped.

Another advantage of the differential bridge output is no net DC voltage across the load. This is accomplished by biasing MONO- and MONO+ outputs at half-supply. This eliminates the coupling capacitor that single supply, single-ended amplifiers require. Eliminating an output coupling capacitor in a typical single-ended configuration forces a single-supply amplifier's half-supply bias voltage across the load. This increases internal IC power dissipation and may permanently damage loads such as speakers.

#### POWER DISSIPATION

Power dissipation is a major concern when designing a successful single-ended or bridged amplifier.

A direct consequence of the increased power delivered to the load by a bridge amplifier is higher internal power dissipation. The LM4946 has a pair of bridged-tied amplifiers driving a handsfree speaker, MONO. The maximum internal power dissipation operating in the bridge mode is twice that of a single-ended amplifier. From Equation (8), assuming a 5V power supply and an  $8\Omega$  load, the maximum MONO power dissipation is 634mW.

$$P_{DMAX-SPKROUT} = 4(V_{DD})^2 / (2\pi^2 R_L)$$
: Bridge Mode (8)

The LM4946 also has a pair of single-ended amplifiers driving stereo headphones,  $R_{OUT}$  and  $L_{OUT}$ . The maximum internal power dissipation for  $R_{OUT}$  and  $L_{OUT}$  is given by equation (9) and (10). From Equations (9) and (10), assuming a 5V power supply and a  $32\Omega$  load, the maximum power dissipation for  $L_{OUT}$  and  $R_{OUT}$  is 40mW, or 80mW total.

 $P_{DMAX-LOUT} = (V_{DD})^2 / (2\pi^2 R_L)$ : Single-ended Mode (9)

$$P_{DMAX-ROUT} = (V_{DD})^2 / (2\pi^2 R_L)$$
: Single-ended Mod(10)

The maximum internal power dissipation of the LM4946 occurs when all three amplifiers pairs are simultaneously on; and is given by Equation (11).

$$P_{DMAX-TOTAL} = P_{DMAX-SPKROUT} + P_{DMAX-LOUT} + P_{DMAX-ROUT}$$
(11)

The maximum power dissipation point given by Equation (11) must not exceed the power dissipation given by Equation (12):

$$P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$$
(12)

The LM4946's  $T_{JMAX} = 150^{\circ}$ C. In the SQ package, the LM4946's  $\theta_{JA}$  is 46°C/W. At any given ambient temperature  $T_A$ , use Equation (12) to find the maximum internal power dissipation supported by the IC packaging. Rearranging Equation (12) and substituting  $P_{DMAX-TOTAL}$  for  $P_{DMAX}$ ' results in Equation (13). This equation gives the maximum ambient temperature that still allows maximum stereo power dissipation without violating the LM4946's maximum junction temperature.

$$T_{A} = T_{JMAX} - P_{DMAX-TOTAL} \theta_{JA}$$
(13)

For a typical application with a 5V power supply and an  $8\Omega$  load, the maximum ambient temperature that allows maximum mono power dissipation without exceeding the maximum junction temperature is approximately 121°C for the SQ package.

$$T_{\text{JMAX}} = P_{\text{DMAX-TOTAL}} \theta_{\text{JA}} + T_{\text{A}}$$
(14)

Equation (14) gives the maximum junction temperature  $T_{J^{-}}$ MAX. If the result violates the LM4946's 150°C, reduce the maximum junction temperature by reducing the power supply voltage or increasing the load resistance. Further allowance should be made for increased ambient temperatures. The above examples assume that a device is a surface mount part operating around the maximum power dissipation point. Since internal power dissipation is a function of output power, higher ambient temperatures are allowed as output power or duty cycle decreases. If the result of Equation (11) is greater than that of Equation (12), then decrease the supply voltage, increase the load impedance, or reduce the ambient temperature. If these measures are insufficient, a heat sink can be added to reduce  $\theta_{JA}$ . The heat sink can be created using additional copper area around the package, with connections to the ground pin(s), supply pin and amplifier output pins. External, solder attached SMT heatsinks such as the Thermalloy 7106D can also improve power dissipation. When adding a heat sink, the  $\theta_{\mathsf{JA}}$  is the sum of  $\theta_{JC},~\theta_{CS},$  and  $\theta_{SA}.~(\theta_{JC}~\text{is the junction-to-case thermal im$ pedance,  $\theta_{\text{CS}}$  is the case-to-sink thermal impedance, and  $\theta_{SA}$  is the sink-to-ambient thermal impedance). Refer to the Typical Performance Characteristics curves for power dissipation information at lower output power levels.

#### POWER SUPPLY BYPASSING

As with any power amplifier, proper supply bypassing is critical for low noise performance and high power supply rejection. Applications that employ a 5V regulator typically use a 1 $\mu$ F in parallel with a 0.1 $\mu$ F filter capacitors to stabilize the regulator's output, reduce noise on the supply line, and improve the supply's transient response. However, their presence does not eliminate the need for a local 1.0 $\mu$ F tantalum bypass capacitor and a parallel 0.1 $\mu$ F ceramic capacitor connected between the LM4946's supply parallel 0.1 $\mu$ Com

ground. Keep the length of leads and traces that connect capacitors between the LM4946's power supply pin and ground as short as possible.

#### SELECTING EXTERNAL COMPONENTS

#### **Input Capacitor Value Selection**

Amplifying the lowest audio frequencies requires high value input coupling capacitor ( $C_i$  in Figures 1 & 2). A high value capacitor can be expensive and may compromise space efficiency in portable designs. In many cases, however, the speakers used in portable systems, whether internal or external, have little ability to reproduce signals below 150Hz. Applications using speakers with this limited frequency response reap little improvement by using large input capacitor.

The internal input resistor ( $R_i$ ), minimum 10k $\Omega$ , and the input capacitor ( $C_i$ ) produce a high pass filter cutoff frequency that is found using Equation (15).

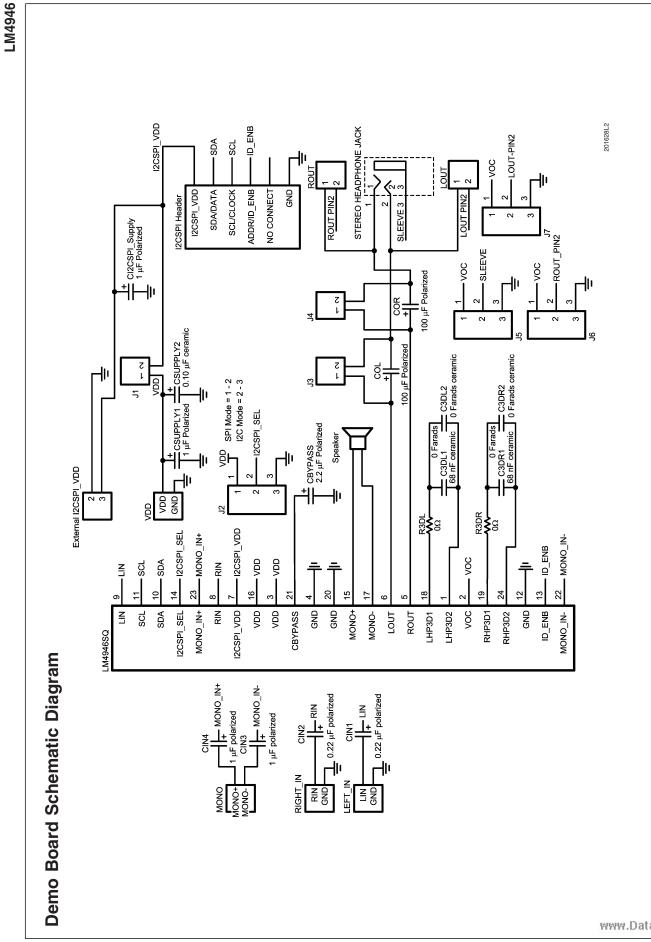
$$f_c = 1 / (2\pi R_i C_i)$$
 (15)

As an example when using a speaker with a low frequency limit of 150Hz, C<sub>i</sub>, using Equation (15) is 0.106 $\mu$ F. The 0.22 $\mu$ F C<sub>i</sub> shown in *Figure 1* allows the LM4946 to drive high efficiency, full range speaker whose response extends below 40Hz.

#### Bypass Capacitor Value Selection

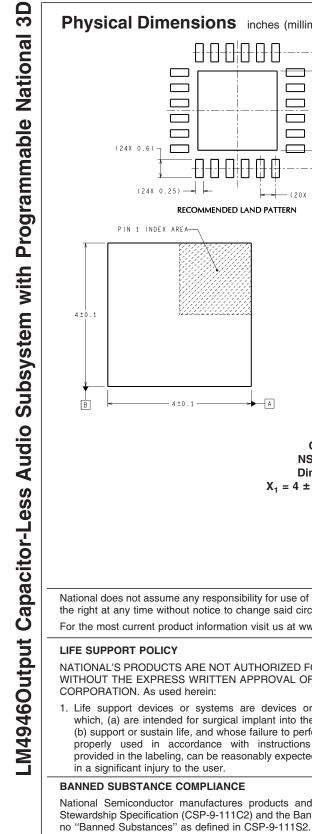
Besides minimizing the input capacitor size, careful consideration should be paid to value of  $C_B$ , the capacitor connected to the BYPASS pin. Since  $C_B$  determines how fast the LM4946 settles to quiescent operation, its value is critical when minimizing turn-on pops. The slower the LM4946's outputs ramp to their quiescent DC voltage (nominally  $V_{DD}/2$ ), the smaller the turn-on pop. Choosing  $C_B$  equal to 2.2µF along with a small value of  $C_i$  (in the range of 0.1µF to 0.33µF), produces a click-less and pop-less shutdown function. As discussed above, choosing  $C_i$  no larger than necessary for the desired bandwidth helps minimize clicks and pops.  $C_B$ 's value should be in the range of 7 to 10 times the value of  $C_i$ . This ensures that output transients are eliminated when power is first applied or the LM4946 resumes operation after shutdown.

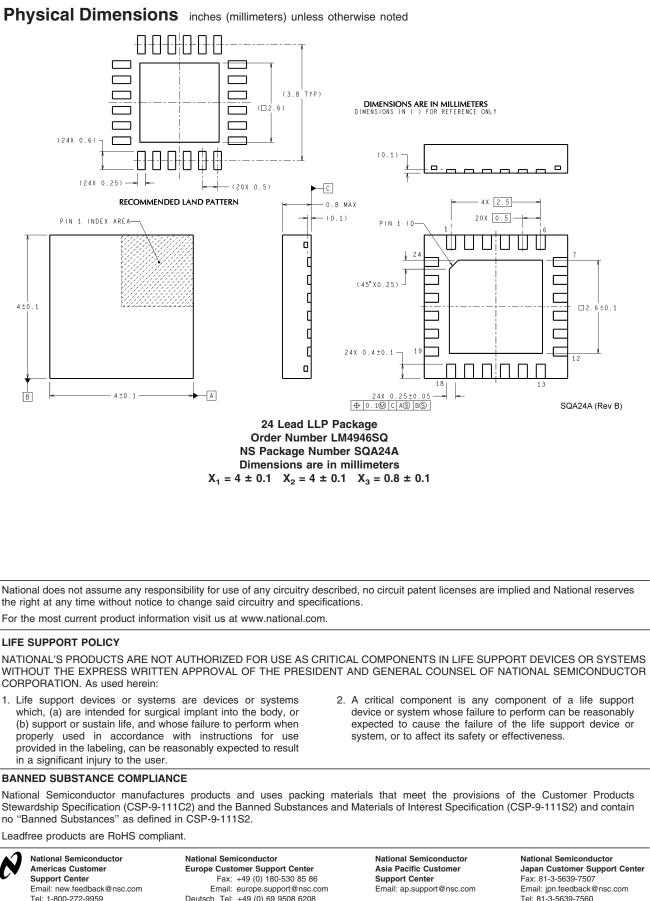
LM4946



<b>Revision History</b>			
Rev	Date	Description	
1.0	01/23/06	Initial release.	

LM4946





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